

CEB6336-VB Datasheet N-Channel 60 V (D-S) MOSFET

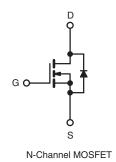
PRODUCT SUMMARY							
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Max)				
60	0.032 at V _{GS} = 10 V	50	66 nC				
00	0.035 at V _{GS} = 4.5 V	40					

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC



D²PAK (TO-263)



ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted) PARAMETER SYMBOL LIMIT UNIT Drain-Source Voltage 60 V_{DS} V Gate-Source Voltage ± 10 V_{GS} Continuous Drain Current^f T_C = 25 °C 50 V_{GS} at 10 V I_D T_C = 100 °C Continuous Drain Current 36 А Pulsed Drain Currenta 200 I_{DM} Linear Derating Factor 1.0 W/°C Linear Derating Factor (PCB Mount)e 0.025 Single Pulse Avalanche Energy^b E_{AS} 400 mJ Maximum Power Dissipation T_C = 25 °C 150 W P_D Maximum Power Dissipation (PCB Mount)e T_A = 25 °C 3.7 Peak Diode Recovery dV/dtc dV/dt 4.5 V/ns Operating Junction and Storage Temperature Range - 55 to + 175 T_J, T_{stg} °C Soldering Recommendations (Peak Temperature)^d 300^d for 10 s

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, $L = 179 \text{ }\mu\text{H}$, $R_g = 25 \Omega$, $I_{AS} = 51 \text{ A}$ (see fig. 12). c. $I_{SD} \le 51 \text{ A}$, $dI/dt \le 250 \text{ }A/\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

f. Current limited by the package, (die current = 51 A).

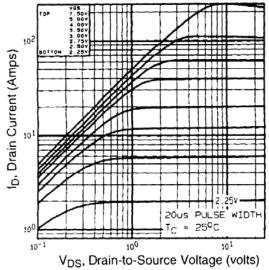
d. 1.6 mm from case.



THERMAL RESISTANCE RATI								
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	_{JA} - 62						
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	- 40			°C/W			
Maximum Junction-to-Case (Drain)	n-to-Case (Drain) R _{thJC} - 1.0		1.0					
ote . When mounted on 1" square PCB (FR-4)	or G-10 material).						
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		-						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		i0 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.070	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		1.0	-	3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 10 \text{ V}$		-	-	± 100	nA	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$		_	-	250		
		V _{GS} = 10 V		= 21 A ^b	-	0.032	-	Ω
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4.5 V	ln	= 15 A ^b	-	0.035	-	
Forward Transconductance	g _{fs}	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 21 \text{ A}^{\text{b}}$		23	-	-	S	
Dynamic	010							
						3000	_	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5$		_	1000	-	pF	
Reverse Transfer Capacitance	C _{rss}			_	200	-		
Total Gate Charge	Qg				-	60	_	+
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 V$ $I_D = 51 A, V_{DS} = 48 V,$		_	10	-	nC	
Gate-Drain Charge	Q _{gd}	vGS - 0.0 v	see fig. 6 and 13 ^b		_	40	-	
Turn-On Delay Time				_	17	_		
Rise Time	t _{d(on)} t _r			-	230	-		
Turn-Off Delay Time	t _{d(off)}		= 30 V, I _D = R _D = 0.56 Ω	51 A, 2, see fig. 10 ^b	_	42	_	ns
Fall Time	t _f			-	110	-	1	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	L _S			-	7.5	-		
Drain-Source Body Diode Characteristic	cs				1	II		1
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50 ^c	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200		
Body Diode Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 51 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- $T_J = 25 \text{ °C}, I_F = 51 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	130	180	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.84	1.3	μC	
Forward Turn-On Time	t _{on}	Intrincic tu	rn on time i	is negligible (turn	on in dor	ningtod b	vl and	<u> </u>

Notes
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 μs; duty cycle ≤ 2 %.
c. Current limited by the package, (Die Current = 51 A).



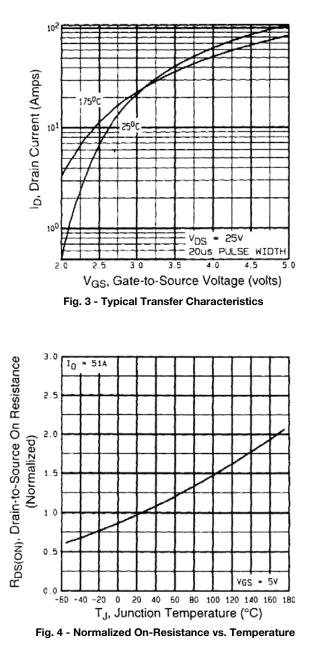


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C





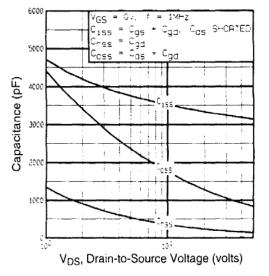


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

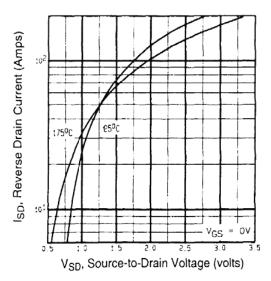


Fig. 7 - Typical Source-Drain Diode Forward Voltage

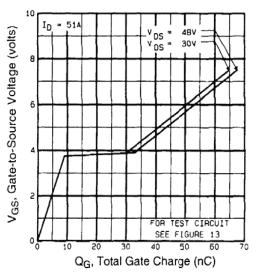
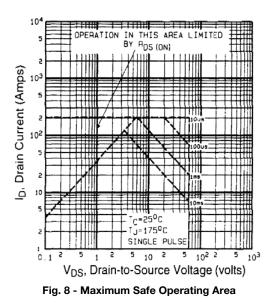


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





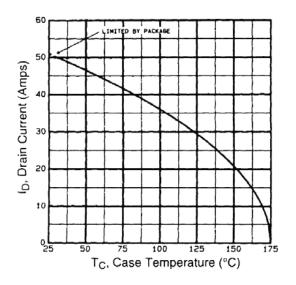


Fig. 9 - Maximum Drain Current vs. Case Temperature

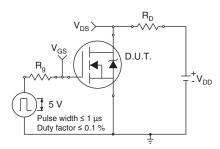


Fig. 10a - Switching Time Test Circuit

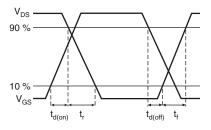


Fig. 10b - Switching Time Waveforms

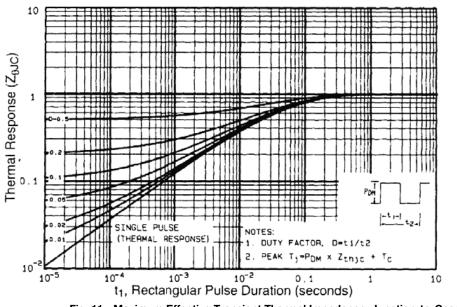


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



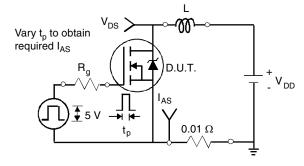


Fig. 12a - Unclamped Inductive Test Circuit

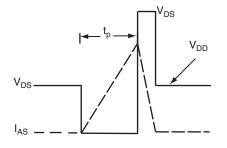


Fig. 12b - Unclamped Inductive Waveforms



Fig. 12c - Maximum Avalanche Energy vs. Drain Current

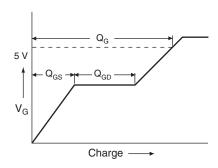


Fig. 13a - Basic Gate Charge Waveform

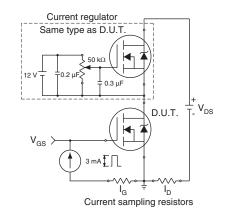
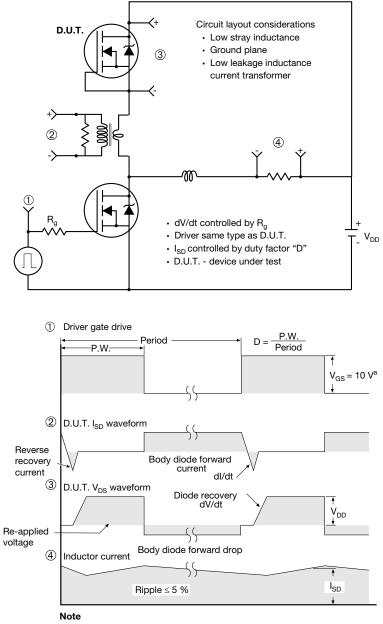


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit

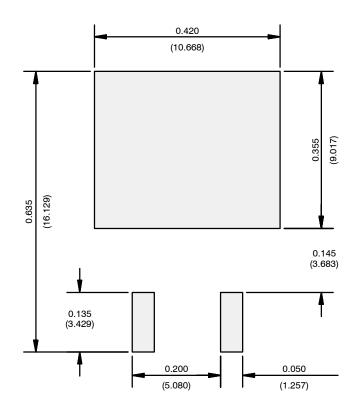


a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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